OE JC185	
3 0	0-2001 U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office
1 o die Honoranie Assistant Sacietal A and Collin	B record the attached original document(s)
1. Name of conveying party(ies): 7-31-7	2. Name and address of receiving party(ies):
Hidenori MIYAKAWA; Yoshio MARUYAMA; Hiroshi YAMAUCHI; Mikiya NAKATA; Takashi AKIGUCHI;	Name: Matsushita Electric Industrial Co., Ltd.
Yoshinori WADA; and Kazuhiro MORI	Street Address: 1006, Oaza Kadoma, Kadoma-shi <u>Osaka-fu, Japan</u>
Additional name(s) of conveying party(ies) attached? No 3. Nature of conveyance:	
X_ Assignment Merger Security Agreement Change of Name Other Execution Date: April 19, 20 and 23, 2001	Additional name(s) & address(es) attached? No
4. Application number(s) or patent number(s):	
If this document is being filed together with a new application A. Patent Application No.(s) 09/818,899 Additional numbers	B. Patent No.(s) , issued
5. Name and address of party to whom correspondence	6. Total number of applications and patents involved: 1
concerning document should be mailed:	
Name: WENDEROTH, LIND & PONACK, L.L.P. Attn: Michael S. Huppert, Esq.	7. Total fee (37 CFR 3.41)\$40.00 X Enclosed (Check No. 46348)
Street Address: 2033 K Street, N.W., Suite 800	Authorized to be charged to deposit account
City: Washington, State: DC ZIP: 20006-1021	8. Deposit account number: 23-0975 (Attach duplicate copy of this page if paying by deposit account)
DO NOT USE T	
9. Statement and signature. To the best of my knowledge and belief, the foregoing information original document. Michael S. Huppert , Reg. No. 40,268 Name of Person Signing Signature	August 31, 2001 Date Total number of pages including cover sheet: 3
OMB No. 0651-0011 (exp. 4/94) Do not detach to	this parties. The same and
FC:581 40.00 Mail documents to be recorded with required cover sheet information:	TO CHARGE ANY DEFICIENCY IN THE FEE FOR THIS PAPER TO DEPOSIT ACCOUNT NO. 23, 2025
Commissioner and Assistant Secre Box Assigr Washington, D	nments
Public burden reporting for this sample cover sheet is estimated to avitime for reviewing the document and gathering the data needed, and comments regarding this burden estimate to the U.S. Patent and Trad Washington, D.C. 20231, and the Office of Management and Budget 20503.	completing and reviewing the sample cover sheet. Send lemark Office, Office of Information Systems, PK2-1000C,

PATENT REEL: 012133 FRAME: 0581

ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned

Hidenori MIYAKAWA, Yoshio MARUYAMA, Hiroshi YAMAUCHI,

Insert Name(s)
of Inventor(s)

Mikiya NAKATA, Takashi AKIGUCHI, Yoshinori WADA, and

Kazuhiro MORI

the undersigned hereby sell(s) and assign(s) to

Insert Name(s) of Assignee(s)

Matsushita Electric Industrial Co., Ltd.

or transfilee(s)

Address

of 1006, Oaza Kadoma, Kadoma-shi, Osaka-fu, Japan

(hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as

ARTICLE WITH ELECTRONIC CIRCUIT FORMED AND METHOD OF
MANUFACTURING THE SAME

Title of Invention

Date of Signing of Application

for which an application for patent in the United States has been executed by the undersigned on April 19, 2001, April 20, 2001, April 19, 2001, April 23, 2001, April 20, 2001, and April 20, 2001, respectively.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

PATENT REEL: 012133 FRAME: 0582 The undersigned hereby grant(s) the firm of WENDEROTH, LIND & PONACK, L.L.P., 2033 K Street, N.W., Suite 800, Washington, DC 20006, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s). Date April 19. 200/, Name of Inventor Hidenori MIN Date april 20. 2001, Name of Inventor yoshio maruyama Date April 19 200/, Name of Inventor Hiros Date April 23 2001, Name of Inventor Mikiya NAKA $\frac{23}{200}$, Name of Inventor $\frac{1}{1120}$ 20 200 /, Name of Inventor Joshing 20.200/, Name of Inventor (This assignment should preferably be acknowledged before a United States Consul. If not, then the execution by the Inventor(s) should be witnessed by at least two witnesses who sign here.) ACKNOWLEDGEMENT _____ day of ______, before me personally came the above-named____ to me personally known as the individual(s) who executed the foregoing assignment, who did acknowledge to me that he (they) executed the same of his (their) own free will for the purposes therein set forth. Official Signature SEAL Official Title The above application may be more particularly identified as follows: Filing Date March 28, 2001 U.S. Application Serial No. _ ___ Atty Docket No. 2001 0367A 533280 Applicant Reference Number _ Title of Invention ARTICLE WITH ELECTRONIC CIRCUIT FORMED AND METHOD OF MANUFACTURING THE SAME

RECORDED: 08/31/2001

PATENT REEL: 012133 FRAME: 0583